onsemi

General Purpose Transistor

PNP Silicon

BC856BM3, NSVBC856BM3

This transistor is designed for general purpose amplifier applications. It is housed in the SOT-723 which is designed for low power surface mount applications.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	-65	V
Collector-Base Voltage	V _{CBO}	-80	V
Emitter-Base Voltage	V _{EBO}	-5.0	V
Collector Current – Continuous	Ι _C	-100	mA

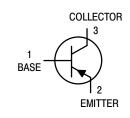
THERMAL CHARACTERISTICS

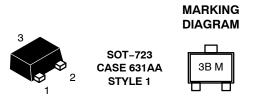
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (Note 1) T _A = 25°C	P _D	265	mW
Derate above 25°C		2.1	mW/°C
Thermal Resistance, Junction to Ambient (Note 1)	R_{\thetaJA}	470	°C/W
Total Device Dissipation Alumina Substrate (Note 2) $T_A = 25^{\circ}C$	P _D	640	mW
Derate above 25°C		5.1	mW/°C
Thermal Resistance, Junction to Ambient (Note 2)	$R_{ hetaJA}$	195	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	−55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR–5 = 1.0 \times 0.75 \times 0.062 in.

2. Alumina = 0.4 \times 0.3 \times 0.024 in. 99.5% alumina.





3B = Specific Device Code M = Date Code

ORDERING INFORMATION

Device	Package	Shipping [†]
BC856BM3T5G	SOT-723 (Pb-Free)	8000 / Tape & Reel
NSVBC856BM3T5G	SOT-723 (Pb-Free)	8000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, <u>BRD8011/D</u>.

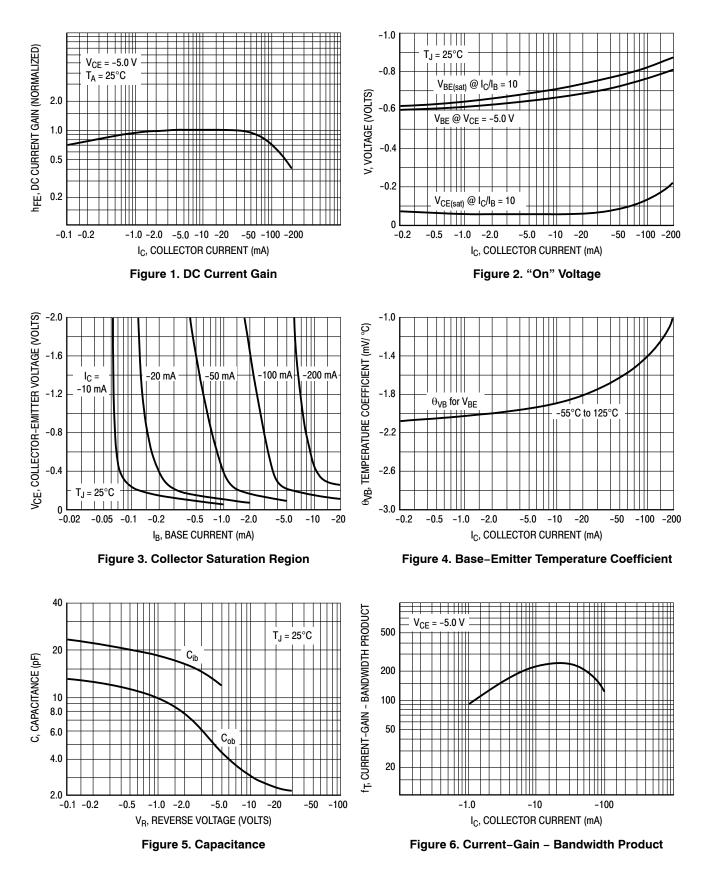
BC856BM3, NSVBC856BM3

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				
Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mA})$	V _{(BR)CEO}	-65	_	-	V
Collector – Emitter Breakdown Voltage ($I_C = -10 \ \mu A$, $V_{EB} = 0$)	V _{(BR)CES}	-80	-	-	V
Collector – Base Breakdown Voltage $(I_C = -10 \ \mu A)$	V _{(BR)CBO}	-80	_	_	V
Emitter – Base Breakdown Voltage $(I_E = -1.0 \ \mu A)$	V _{(BR)EBO}	-5.0	_	_	V
	I _{CBO}	-		-15 -4.0	nA μA
ON CHARACTERISTICS					
DC Current Gain (I _C = -10 μ A, V _{CE} = -5.0 V) (I _C = -2.0 mA, V _{CE} = -5.0 V)	h _{FE}	220	150 290	_ 475	-
Collector – Emitter Saturation Voltage (I _C = –10 mA, I _B = –0.5 mA) (I _C = –100 mA, I _B = –5.0 mA)	V _{CE(sat)}	-	-	-0.3 -0.65	V
Base – Emitter Saturation Voltage (I _C = –10 mA, I _B = –0.5 mA) (I _C = –100 mA, I _B = –5.0 mA)	V _{BE(sat)}		-0.7 -0.9		V
Base – Emitter Voltage (I _C = -2.0 mA, V _{CE} = -5.0 V) (I _C = -10 mA, V _{CE} = -5.0 V)	V _{BE(on)}	-0.6 _		-0.75 -0.82	mV
SMALL-SIGNAL CHARACTERISTICS	•			•	
Current – Gain – Bandwidth Product ($I_C = -10 \text{ mA}$, $V_{CE} = -5.0 \text{ Vdc}$, f = 100 MHz)	f _T	100	_	-	MHz
Output Capacitance (V _{CB} = -10 V, f = 1.0 MHz)	C _{obo}	_	-	4.5	pF
Noise Figure (I_C = -0.2 mA, V_CE = -5.0 Vdc, R_S = 2.0 k\Omega, f = 1.0 kHz, BW = 200 Hz)	NF	-	-	10	dB

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TYPICAL CHARACTERISTICS





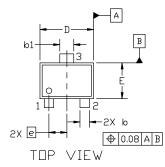


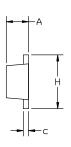
SOT-723 1.20x0.80x0.50, 0.40P CASE 631AA ISSUE E

DATE 24 JAN 2024

NDTES:

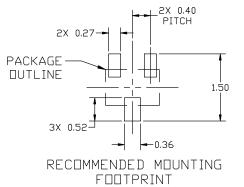
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSION: MILLIMETERS. 1.
- 2.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM З. LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS OR GATE BURRS.



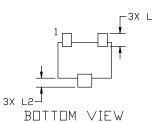


SIDE VIEW

		MILLIMETERS			
	DIM	MIN.	NDM.	MAX.	
1	А	0.45	0.50	0.55	
	b	0.15	0.21	0.27	
	b1	0.25	0.31	0.37	
	С	0.07	0.12	0.17	
	D	1.15	1.20	1.25	
	E	0.75	0.80	0.85	
	e	0.40 BSC			
	Н	1.15	1.20	1.25	
	L	0.29 REF			
	L2	0.15	0.20	0.25	



*For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.



GENERIC **MARKING DIAGRAM***



XX = Specific Device Code Μ = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

2. EMITTER 2.	II: STYLE 3: ANODE PIN 1. ANODE N/C 2. ANODE CATHODE 3. CATHODE	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. GATE 2. SOURCE 3. DRAIN	
DOCUMENT NUMBER: 98AON12989D Electronic versions are uncontrolled except when accessed d Printed versions are uncontrolled except when stamped "CON				
DESCRIPTION: SOT-723 1.20x0.80x0.50, 0.				PAGE 1 OF 1

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